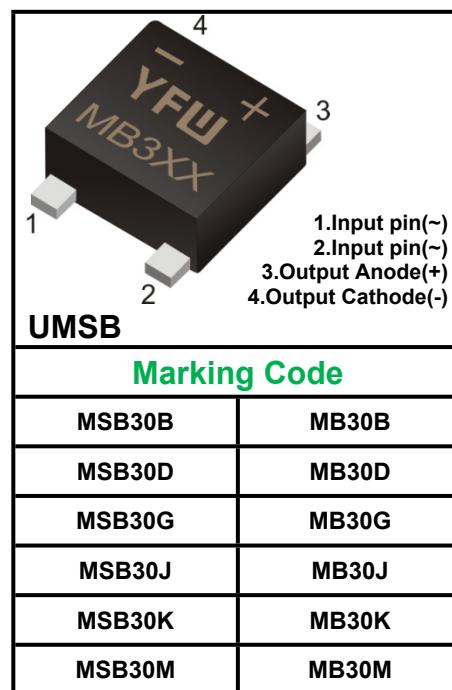


**3A SURFACE MOUNT GLASS PASSIVATED BRIDGE**
**RECTIFIER Reverse Voltage - 100 to 1000 V**
**Forward Current – 3A**
**FEATURES**

- ◆ High current capability
- ◆ Low forward voltage drop
- ◆ Glass Passivated Chip Junction
- ◆ Low power loss, high efficiency
- ◆ Lead free in comply with EU RoHS 2011/65/EU directives

**MECHANICAL DATA**

- ◆ Case: UMSB
- ◆ Terminals: Solderable per MIL-STD-750, Method 2026
- ◆ Approx. Weight: 233.7mg / 0.00824oz


**Maximum Ratings and Electrical characteristics**

Ratings at 25 °C ambient temperature unless otherwise specified.

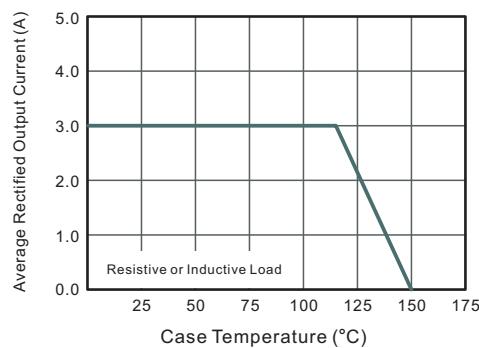
Single phase half-wave 60 Hz, resistive or inductive load, for capacitive load current derate by 20 %.

Parameter	Symbols	MSB30B	MSB30D	MSB30G	MSB30J	MSB30K	MSB30M	Units
Maximum Repetitive Peak Reverse Voltage	<b>V<sub>RRM</sub></b>	100	200	400	600	800	1000	<b>V</b>
Maximum RMS voltage	<b>V<sub>RMS</sub></b>	70	140	280	420	560	700	<b>V</b>
Maximum DC Blocking Voltage	<b>V<sub>DC</sub></b>	100	200	400	600	800	1000	<b>V</b>
Average Rectified Output Current at T <sub>c</sub> = 125 °C	<b>I<sub>o</sub></b>	3						<b>A</b>
Peak Forward Surge Current 8.3 ms Single Half Sine-Wave Superimposed on Rated Load(JEDEC method)	<b>I<sub>FSM</sub></b>	80						<b>A</b>
Forward Voltage per element at 3.0A	<b>V<sub>F</sub></b>	1.1						<b>V</b>
Maximum DC Reverse Current @T <sub>A</sub> =25°C at Rated DC Blocking Voltage @T <sub>A</sub> =125°C	<b>I<sub>R</sub></b>	5 100						<b>μA</b>
Typical Junction Capacitance <sup>(Note1)</sup>	<b>C<sub>j</sub></b>	40						<b>pF</b>
Operating and Storage Temperature Range	<b>T<sub>j</sub>, T<sub>stg</sub></b>	-55 ~ +150						<b>°C</b>

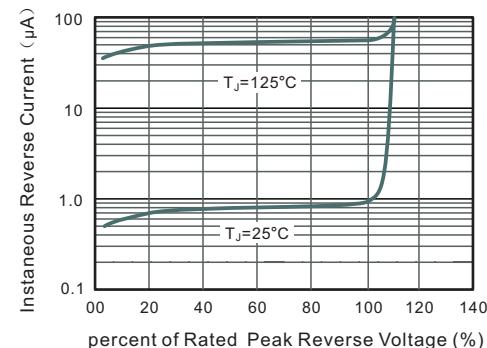
(1) Measured at 1 MHz and applied reverse voltage of 4 V D.C

(2) Mounted on glass epoxy PC board with 4×1.5"×1.5" (3.81×3.81 cm) copper pad.

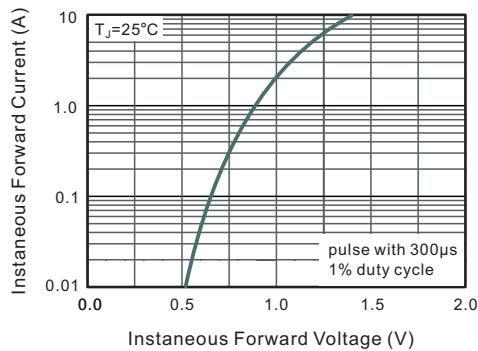
**Fig.1 Average Rectified Output Current Derating Curve**



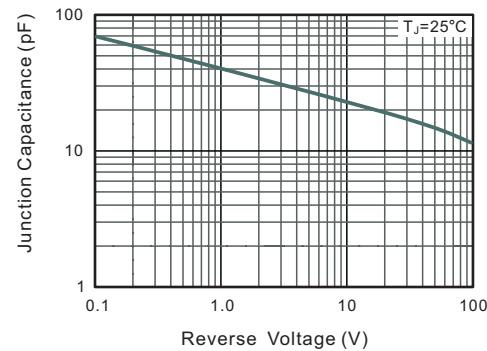
**Fig.2 Typical Reverse Characteristics**



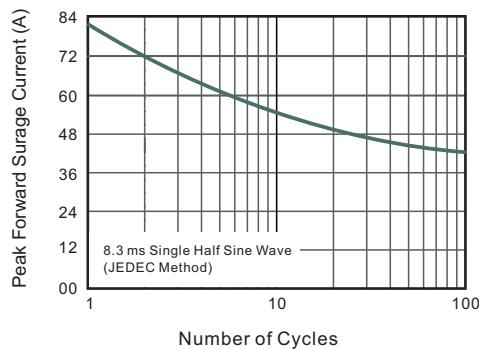
**Fig.3 Typical Instantaneous Forward Characteristics**



**Fig.4 Typical Junction Capacitance**



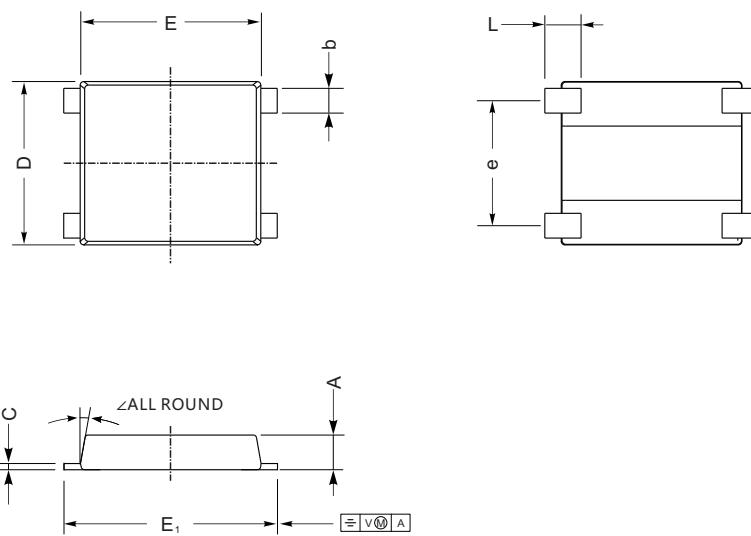
**Fig.5 Maximum Non-Repetitive Peak Forward Surge Current**



**Package Outline**

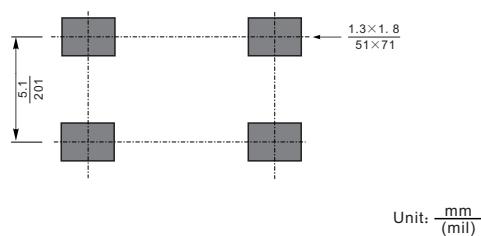
**UMSB**

Plastic surface mounted package; 4leads



UNIT		A	C	D	E	E <sub>1</sub>	L	e	b	∠
mm	max	1.5	0.29	7.0	7.6	8.9	1.6	5.3	1.15	10°
	min	1.3	0.17	6.2	7.1	8.4	1.0	4.9	0.95	
mil	max	59	12	276	299	350	55	209	45	10°
	min	51	7	244	280	331	31.5	193	37	

**The recommended mounting pad size**



**Summary of Packing Options**

Package	Packing Description	Packing Quantity	Industry Standard
UMSB	Tape/Reel,13"reel	3000	EIA-481-1